NCE N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

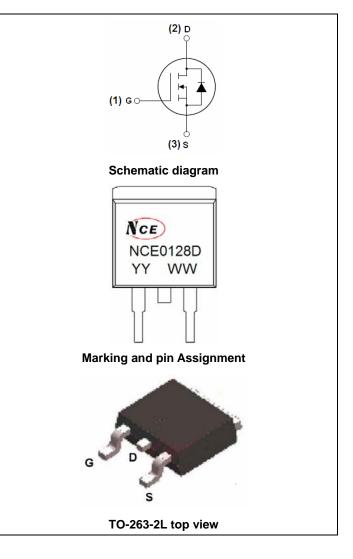
The NCE0128D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

GENERAL FEATURES

- $V_{DS} = 100V, I_D = 28A$ $R_{DS(ON)} < 26m\Omega @ V_{GS} = 10V (Typ: 13.3 m\Omega)$
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0128D	NCE0128D	TO-263-2L	-	-	-

Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	28	Α
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	20	Α
Pulsed Drain Current	I _{DM}	190	Α
Maximum Power Dissipation	P _D	63	W
Derating factor		0.42	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	550	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$

NCE0128D

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	2.4	°C/W	
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Electrical Characteristics (TA=25°C unless otherwise noted)

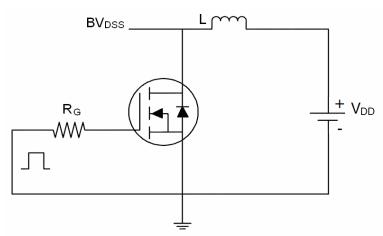
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	•		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =16A		13.3	26	mΩ
Forward Transconductance	g FS	V _{DS} =25V,I _D =16A	30			S
Dynamic Characteristics (Note4)	•					
Input Capacitance	C _{lss})/ O5)/// O//		3700		PF
Output Capacitance	Coss	V_{DS} =25V, V_{GS} =0V,		630		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		330		PF
Switching Characteristics (Note 4)	•		•			
Turn-on Delay Time	t _{d(on)}			12		nS
Turn-on Rise Time	t _r	V _{DD} =50V,I _D =16A		55		nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =2.5 Ω		45		nS
Turn-Off Fall Time	t _f			47		nS
Total Gate Charge	Qg	V 00VI 40A		95		nC
Gate-Source Charge	Q _{gs}	V _{DS} =80V,I _D =16A,		18		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V		25		nC
Drain-Source Diode Characteristics	•		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =16A		0.85	1.2	V
Diode Forward Current (Note 2)	Is				57	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 16A		140	220	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3) 650 10		1000	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

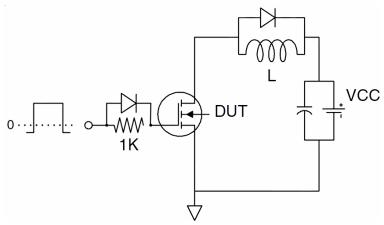
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω

Test circuit

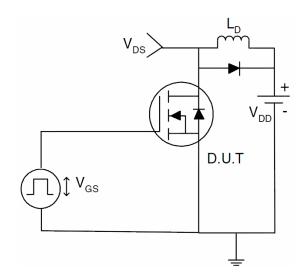
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

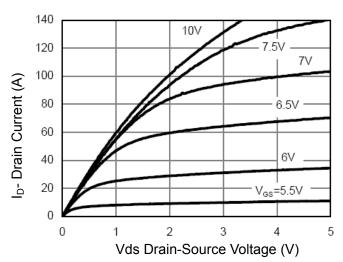


Figure 1 Output Characteristics

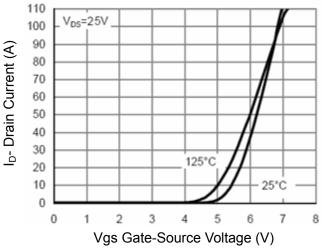


Figure 2 Transfer Characteristics

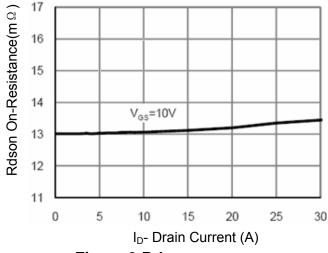


Figure 3 Rdson- Drain Current

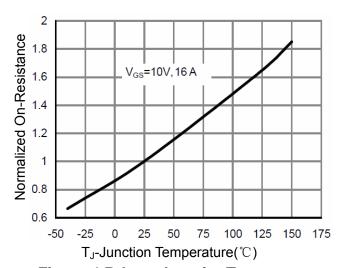


Figure 4 Rdson-JunctionTemperature

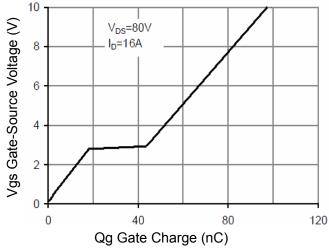


Figure 5 Gate Charge

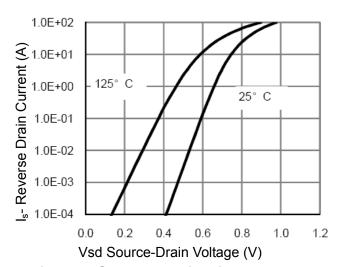
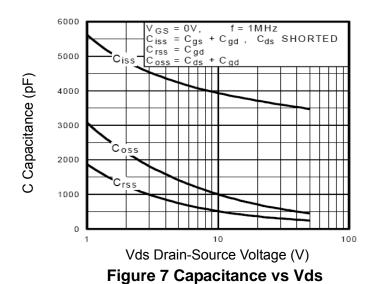


Figure 6 Source- Drain Diode Forward



OPERATION IN THIS AREA LIMITED

BY RDS(on)

10

T_C = 25°C

T_J = 175°C

Single Pulse

1 10 100 1000

Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area

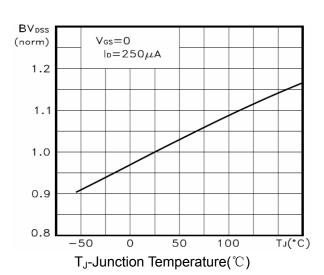


Figure 9 BV_{DSS} vs Junction Temperature

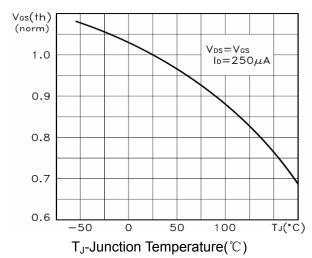


Figure 10 V_{GS(th)} vs Junction Temperatur

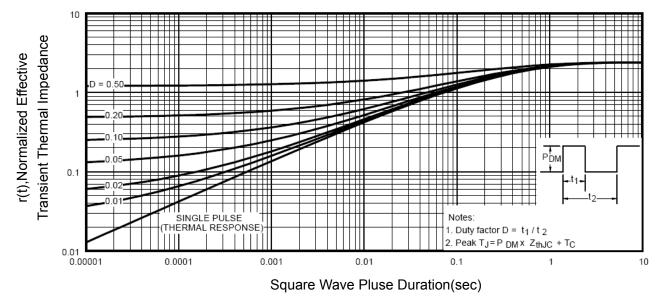
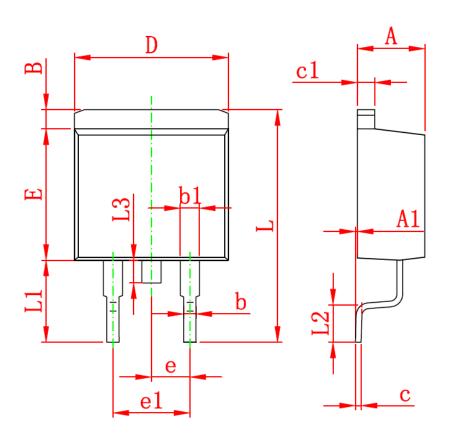
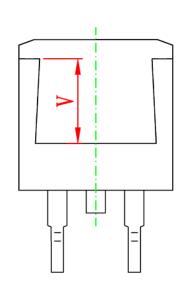


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-263-2L PACKAGE INFORMATION





Symbol	Dimensions 1	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
e	2.540 (TYP.)		0.100 (TYP.)		
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600 REF.		0.220 REF.		

Pb Free Product

NCE0128D

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